

SPECIFICATION AMENDMENTS:

Please amend the specification as follows:

Page 1, line 3, through line 7, please amend the current paragraph as follows:

--The rights of priority are claimed under 35 USC §119 of U.S. Provisional

Application No. 60/413,780, filed September 27, 2002.

Background of the Invention

The present invention relates to a method of forming a semiconductor chip, and more specifically to formation of laser chip markers for passive alignment.--

